

RELIABILITY REPORT FOR MAX140CPL+

PLASTIC ENCAPSULATED DEVICES

June 3, 2009

MAXIM INTEGRATED PRODUCTS

120 SAN GABRIEL DR. SUNNYVALE, CA 94086

Approved by	
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Quality Assurance	
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Conclusion

The MAX140CPL+ successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

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I. Device Description

A. General

The MAX138/MAX139 are 3 1/2 digit A/D converters (ADCs) with on-board LDC (MaX138 and LED (MAX139) dispaly drivers. The MAX138/MAX139 also contain a charge pump voltage inverter. the charge-pump inverter allows the MAX138/MAX139 to measure both ositive and negative input voltages while operating form a single power supply voltage from +2.5 to +7V. the operating circuits of the MAX138/MAX139 are smillar to those of the ICL7136 and ICL7137 respectively, except the MAX138/MAX139 have an internal oscillator and an external charge-pump capacitor connected to pins 38 and 40.

MAX140 is a low segment-current version of the MAX139 intended for use with low-currrent LED dispalys.



II. Manufacturing Information

3 1/2 Digit ADC with Reference, Charge Pump, and Direct LED Drivers

- B. Process:
- C. Number of Device Transistors:
- D. Fabrication Location:
- E. Assembly Location:
- F. Date of Initial Production:

III. Packaging Information

A. Package Type:	40-pin PDIP
B. Lead Frame:	Copper
C. Lead Finish:	100% matte Tin
D. Die Attach:	Conductive Epoxy
E. Bondwire:	Gold (1.3 mil dia.)
F. Mold Material:	Epoxy with silica filler
G. Assembly Diagram:	#05-0101-0104
H. Flammability Rating:	Class UL94-V0
I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C	Level 1
J. Single Layer Theta Ja:	60°C/W
K. Single Layer Theta Jc:	20°C/W

IV. Die Information

A. Dimensions:	137 X 153 mils
B. Passivation:	Si ₃ N ₄ /SiO ₂ (Silicon nitride/ Silicon dioxide
C. Interconnect:	Aluminum/0.5% Cu
D. Backside Metallization:	None
E. Minimum Metal Width:	Metal1 = 0.5 / Metal2 = 0.6 / Metal3 = 0.6 microns (as drawn)
F. Minimum Metal Spacing:	Metal1 = 0.45 / Metal2 = 0.5 / Metal3 = 0.6 microns (as drawn)
G. Bondpad Dimensions:	5 mil. Sq.
H. Isolation Dielectric:	SiO ₂
I. Die Separation Method:	Wafer Saw

M6

Oregon

Pre 1997

ATP Philippines



V. Quality Assurance Information

A. Quality Assurance Contacts:	Ken Wendel (Director, Reliability Engineering) Bryan Preeshl (Managing Director of QA)
B. Outgoing Inspection Level:	0.1% for all electrical parameters guaranteed by the Datasheet.0.1% For all Visual Defects.
C. Observed Outgoing Defect Rate:	< 50 ppm
D. Sampling Plan:	Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (λ) is calculated as follows:

 $\lambda = \frac{1}{\text{MTTF}} = \frac{1.83}{192 \times 4340 \times 80 \times 2}$ (Chi square value for MTTF upper limit) $\lambda = 13.3 \times 10^{-9}$ $\lambda = 13.3 \text{ F.I.T.} (60\% \text{ confidence level @ 25°C})$

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly 1000 hour life test monitors on its processes. This data is published in the Product Reliability Report found at http://www.maximic.com/. Current monitor data for the M5 Process results in a FIT Rate of 3.2 @ 25C and 54.8 @ 55C (0.8 eV, 60% UCL)

B. Moisture Resistance Tests

The industry standard 85°C/85%RH or HAST testing is monitored per device process once a quarter.

C. E.S.D. and Latch-Up Testing

The AD22-2 die type has been found to have all pins able to withstand a HBM transient pulse of +/-1000 V per Mil-Std 883 Method 3015.7. Latch-Up testing has shown that this device withstands a current of +/-100 mA.



MAX140CPL+ TEST ITEM **TEST CONDITION** FAILURE SAMPLE SIZE NUMBER OF **IDENTIFICATION** FAILURES Static Life Test (Note 1) Ta = 135°C **DC** Parameters 80 0 Biased & functionality Time = 192 hrs. Moisture Testing (Note 2) 85/85 Ta = 85°C **DC** Parameters 77 0 RH = 85% & functionality Biased Time = 1000hrs. Mechanical Stress (Note 2) 0 Temperature -65°C/150°C **DC** Parameters 77 Cycle 1000 Cycles & functionality Method 1010

Note 1: Life Test Data may represent plastic DIP qualification lots.

Note 2: Generic Package/Process data

Table 1 Reliability Evaluation Test Results